

# TEMIC

Siliconix

# SMP60N06-18

## N-Channel Enhancement-Mode Transistor, 18-m $\Omega$ r<sub>DS(on)</sub>

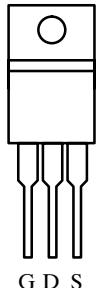
**175°C Maximum Junction Temperature<sup>a</sup>**

### Product Summary

V <sub>DS</sub> (V)	r <sub>DS(on)</sub> ( $\Omega$ )	I <sub>D</sub> (A)
60	0.018	60

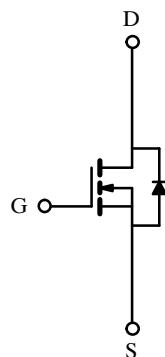
See lower-cost version: SUP50N06-18

TO-220AB



DRAIN connected to TAB

Top View



N-Channel MOSFET

### Absolute Maximum Ratings (T<sub>C</sub> = 25°C Unless Otherwise Noted)

Parameter	Symbol	Limit	Unit
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	T <sub>C</sub> = 25°C	I <sub>D</sub>	A
	T <sub>C</sub> = 100°C		
Pulsed Drain Current	I <sub>DM</sub>	240	
Avalanche Current	I <sub>AR</sub>	60	
Avalanche Energy	L = 0.1 mH	I <sub>AR</sub>	mJ
Repetitive Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AR</sub>	
Power Dissipation	T <sub>C</sub> = 25°C	P <sub>D</sub>	W
	T <sub>C</sub> = 100°C		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	−55 to 175	°C
Lead Temperature (1/16" from case for 10 sec.)	T <sub>L</sub>	300	

### Thermal Resistance Ratings

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient	R <sub>thJA</sub>	°C/W	80	
Junction-to-Case	R <sub>thJC</sub>		1.2	
Case-to-Sink	R <sub>thCS</sub>	1.0		

Notes:

a. Duty cycle ≤1%

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**Specifications ( $T_J = 25^\circ\text{C}$  Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_{DS} = 1 \text{ mA}$	2.0		4.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			$\pm 500$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			25	$\mu\text{A}$
		$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125^\circ\text{C}$			250	
		$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 175^\circ\text{C}$			500	
On-State Drain Current <sup>b</sup>	$I_{D(\text{on})}$	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}$	60			A
Drain-Source On-State Resistance <sup>b</sup>	$r_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.013	0.018	$\Omega$
		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125^\circ\text{C}$		0.023	0.030	
		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175^\circ\text{C}$		0.026	0.036	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$		45		S
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		2600		$\text{pF}$
Output Capacitance	$C_{oss}$			800		
Reversen Transfer Capacitance	$C_{rss}$			200		
Total Gate Charge <sup>c</sup>	$Q_g$	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$		85	100	$\text{nC}$
Gate-Source Charge <sup>c</sup>	$Q_{gs}$			15	20	
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			35	50	
Turn-On Delay Time <sup>c</sup>	$t_{d(\text{on})}$	$V_{DD} = 30 \text{ V}, R_L = 1 \Omega$ $I_D = 30 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		15	30	$\text{ns}$
Rise Time <sup>c</sup>	$t_r$			20	35	
Turn-Off Delay Time <sup>c</sup>	$t_{d(\text{off})}$			50	65	
Fall Time <sup>c</sup>	$t_f$			20	30	
<b>Source-Drain Diode Ratings and Characteristics (<math>T_C = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_s$				60	$\text{A}$
Pulsed Current	$I_{SM}$				240	
Forward Voltage <sup>b</sup>	$V_{SD}$	$I_F = 60 \text{ A}, V_{GS} = 0 \text{ V}$			2.0	V
Reverse Recovery Time	$t_{rr}$	$I_F = 60 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$			160	$\text{ns}$
Peak Reverse Recovery Current	$I_{RM(\text{REC})}$				13	
Reverse Recovery Charge	$Q_{rr}$				1.0	$\mu\text{C}$

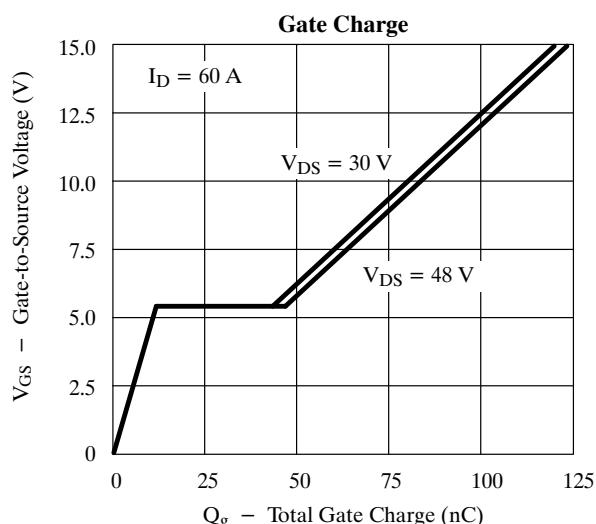
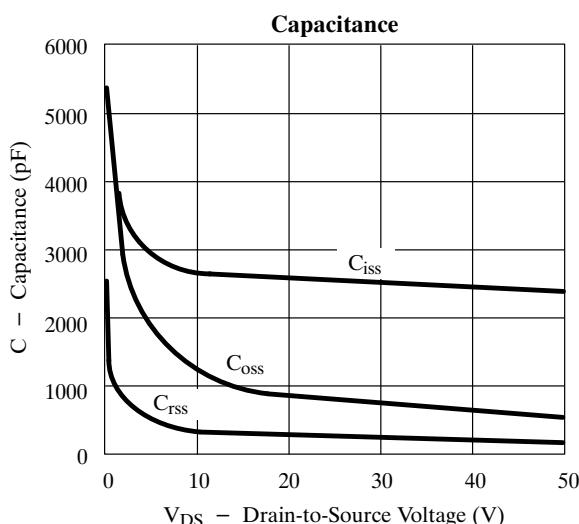
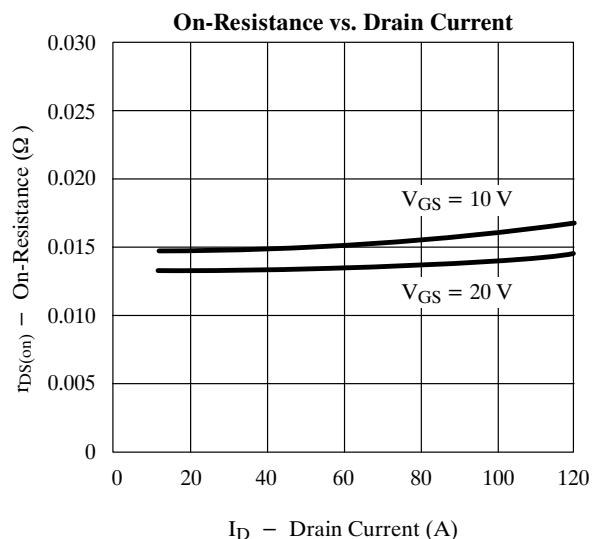
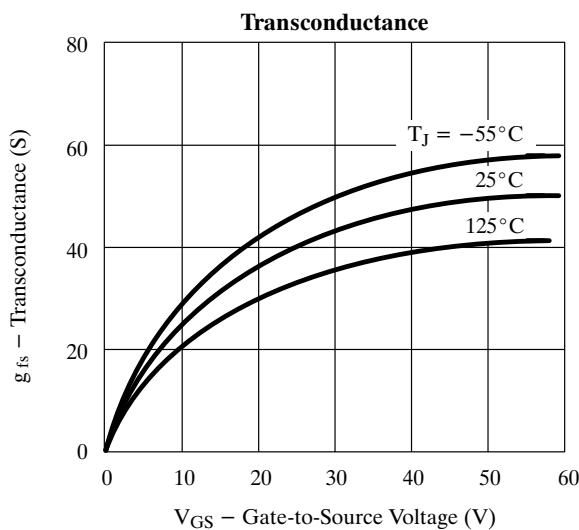
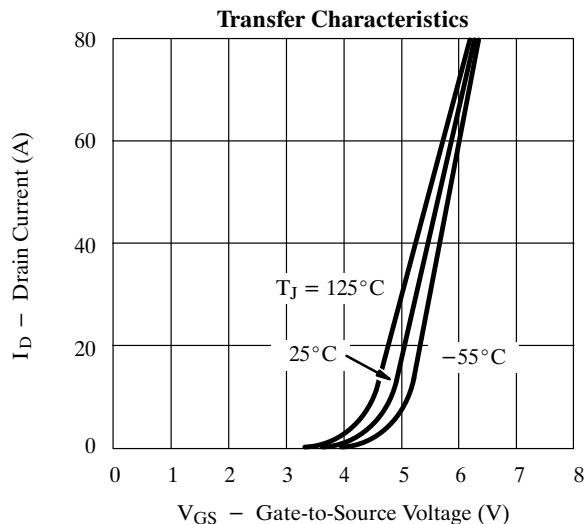
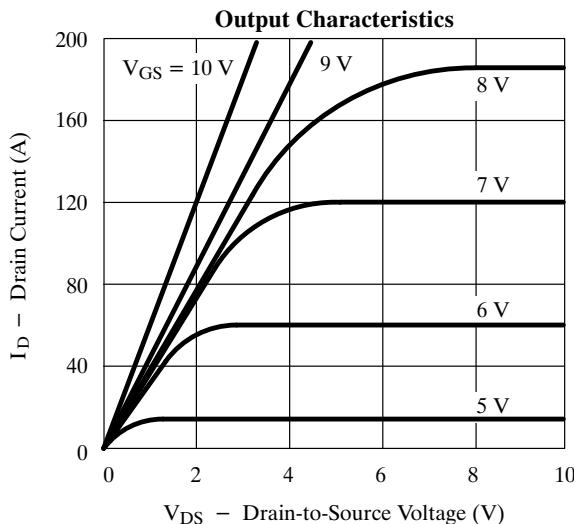
Notes:

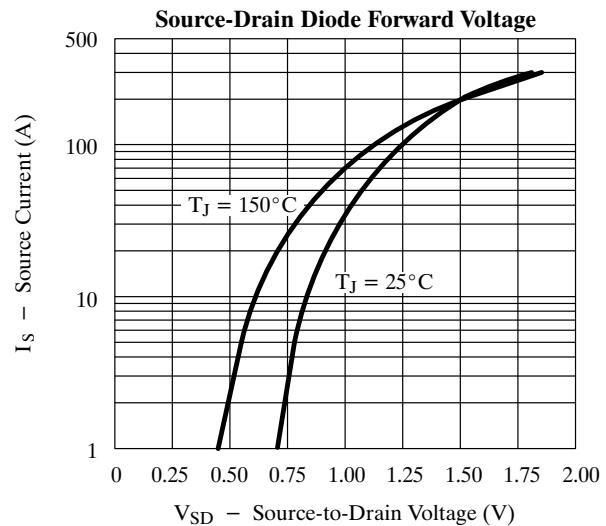
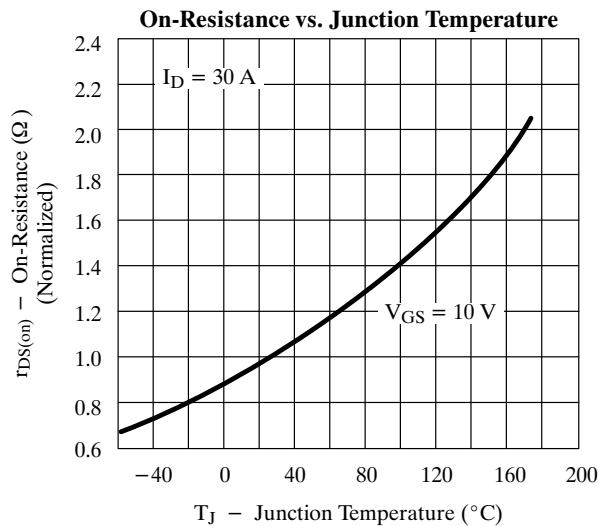
a. For design aid only; not subject to production testing.

b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

c. Independent of operating temperature.

## Typical Characteristics (25°C Unless Otherwise Noted)



**SMP60N06-18****Typical Characteristics (25°C Unless Otherwise Noted)****Thermal Ratings**